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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications. Offering both low on-state voltage and minimal switching loss, the IGBT is well suited for resonant or soft switching applications. Incorporated into the device is a rugged co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Low Gate Charge
- 5 µs Short-Circuit Capability
- These are Pb-Free Devices

Typical Applications

- Inverter Welding Machines
- Microwave Ovens
- Industrial Switching
- Motor Control Inverter

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	lc	80 40	Α
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	320	Α
Diode forward current @ Tc = 25°C @ Tc = 100°C	l _F	80 40	А
Diode pulsed current, T _{pulse} limited by T _{Jmax}	I _{FM}	320	Α
Gate-emitter voltage	V_{GE}	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	260 104	W
Short–Circuit Withstand Time $V_{GE} = 15 \text{ V}, V_{CE} = 600 \text{ V}, T_J \le 150^{\circ}\text{C}$	T _{sc}	5	μs
Operating junction temperature range	T_J	-55 to +150	°C
Storage temperature range	T _{stg}	-55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

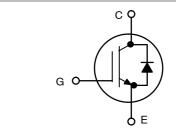
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

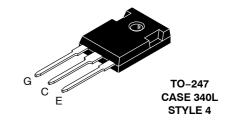


ON Semiconductor®

http://onsemi.com

40 A, 1200 V V_{CEsat} = 1.90 V E_{off} = 1.40 mJ





MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120LWG	TO-247 (Pb-Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ hetaJC}$	0.48	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•			•		
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	V _{(BR)CES}	1200	_	-	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 25 A, T _J = 150°C	V _{CEsat}	1.45 -	1.90 2.1	2.35	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_{C} = 400 \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V _{GE} = 0 V, V _{CE} = 1200 V V _{GE} = 0 V, V _{CE} = 1200 V, T _{J =} 150°C	I _{CES}	- -	-	0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	_	-	200	nA
DYNAMIC CHARACTERISTIC		•				1
Input capacitance		C _{ies}	-	10,400	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	245	_	
Reverse transfer capacitance	1	C _{res}	-	185	-	
Gate charge total		Q_g	-	420	-	nC
Gate to emitter charge	V _{CE} = 600 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	95	-	
Gate to collector charge		Q _{gc}	-	178	-	
SWITCHING CHARACTERISTIC, INDUCT	TIVE LOAD					-
Turn-on delay time		t _{d(on)}	-	140	-	
Rise time	1	t _r	_	40	_	ns
Turn-off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 600 \text{ V, } I_C = 40 \text{ A}$	t _{d(off)}	-	360	-	
Fall time	$R_g = 10 \Omega$ $V_{GF} = 0 \text{ V/ } 15 \text{ V}$	t _f	-	132	-	
Turn-on switching loss	VGE = 0 V/ 13 V	E _{on}	-	5.5	-	1
Turn-off switching loss		E _{off}	-	1.40	-	mJ
Turn-on delay time	$T_{J} = 125^{\circ}\text{C}$ $V_{CC} = 600 \text{ V, } I_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t _{d(on)}	-	134	-	
Rise time		t _r	-	44	-]
Turn-off delay time		t _{d(off)}	-	380	-	ns
Fall time		t _f	-	185	-	
Turn-on switching loss		E _{on}	İ	6.8	-	ml
Turn-off switching loss		E _{off}	_	2.6	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A, T _J = 150°C	V _F	- -	1.6 1.8	1.8 -	V

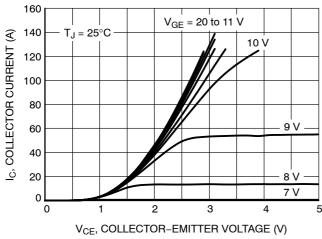


Figure 1. Output Characteristics

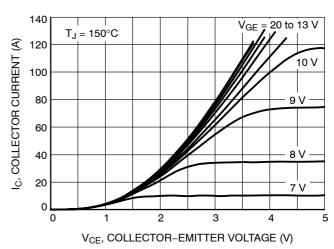


Figure 2. Output Characteristics

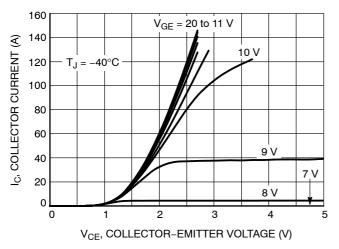


Figure 3. Output Characteristics

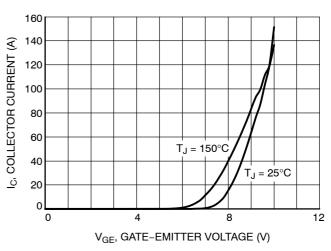


Figure 4. Typical Transfer Characteristics

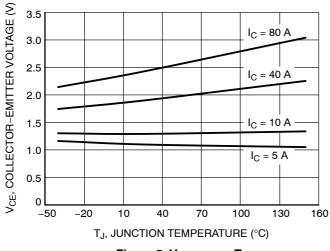


Figure 5. V_{CE(sat)} vs. T_J

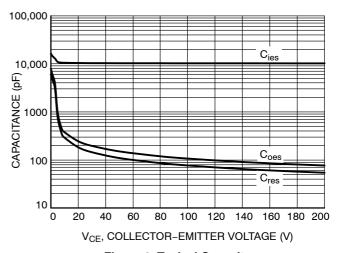
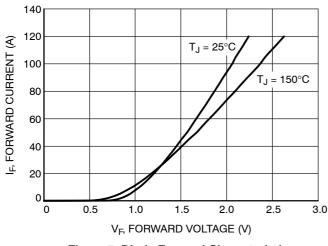


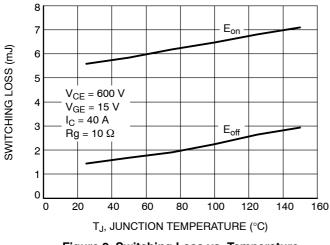
Figure 6. Typical Capacitance



20 V_{CE} = 600 V V_{CE} = 600 V 15 V_{CE} = 600 V 0 60 120 180 240 300 360 420 480 Q_G, GATE CHARGE (nC)

Figure 7. Diode Forward Characteristics

Figure 8. Typical Gate Charge



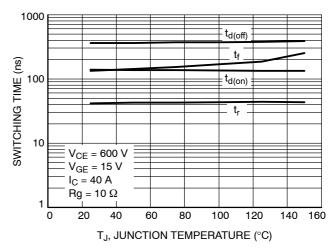
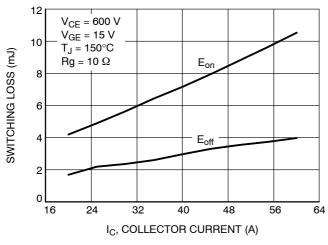


Figure 9. Switching Loss vs. Temperature

Figure 10. Switching Time vs. Temperature



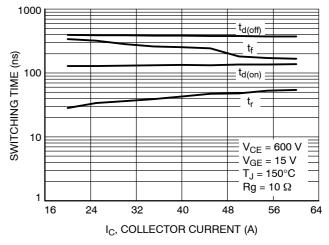


Figure 11. Switching Loss vs. I_C

Figure 12. Switching Time vs. I_C

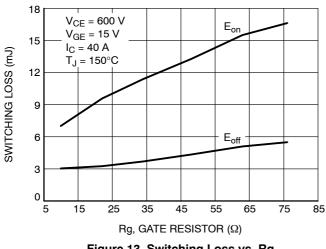


Figure 13. Switching Loss vs. Rg

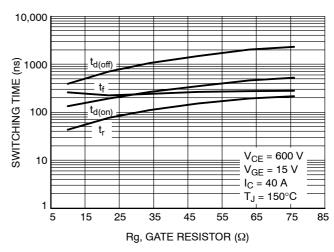


Figure 14. Switching Time vs. Rg

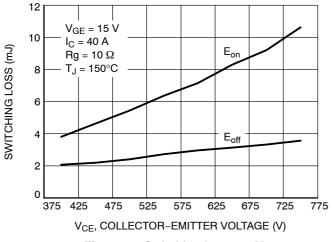


Figure 15. Switching Loss vs. V_{CE}

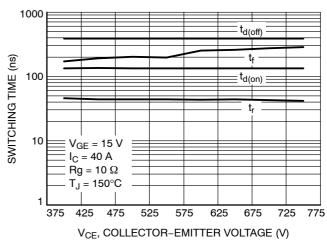


Figure 16. Switching Time vs. V_{CE}

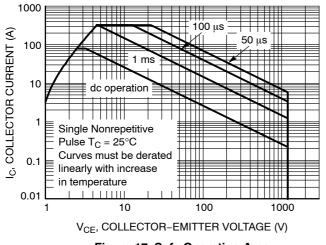


Figure 17. Safe Operating Area

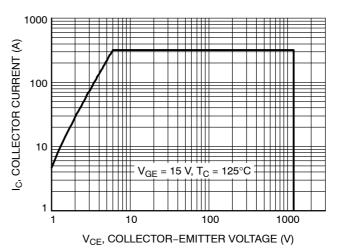


Figure 18. Reverse Bias Safe Operating Area

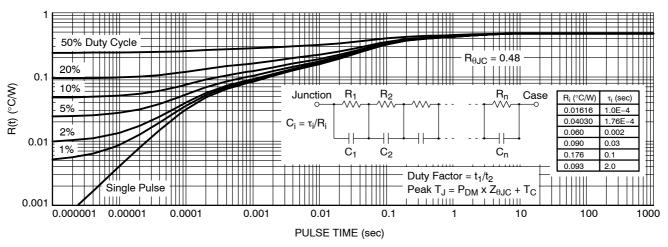


Figure 19. IGBT Transient Thermal Impedance

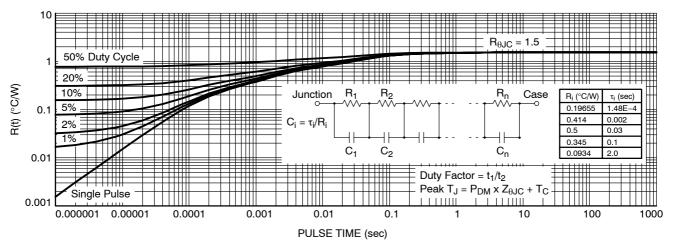


Figure 20. Diode Transient Thermal Impedance

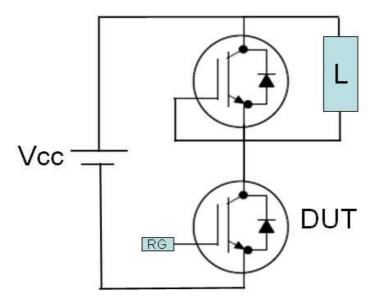


Figure 21. Test Circuit for Switching Characteristics

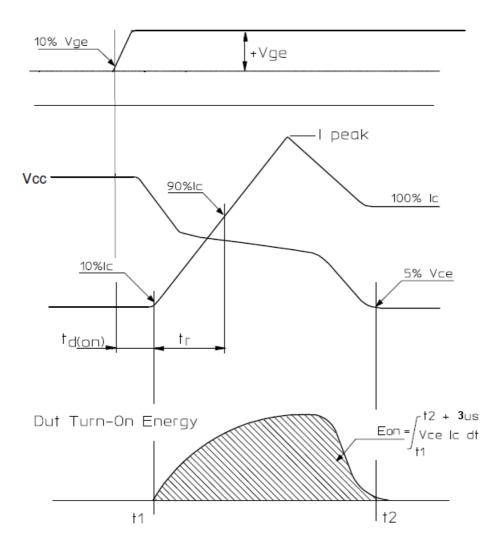


Figure 22. Definition of Turn On Waveform

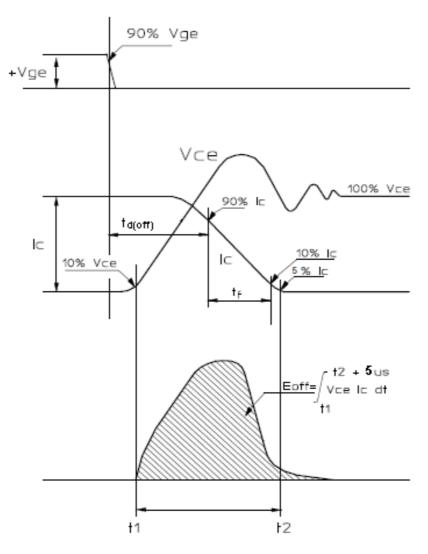
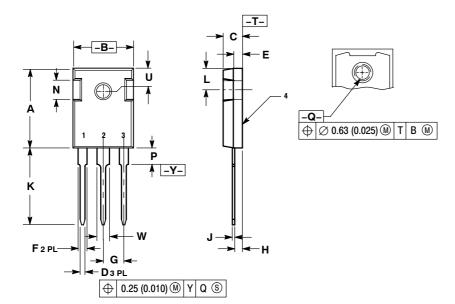


Figure 23. Definition of Turn Off Waveform

PACKAGE DIMENSIONS

TO-247 CASE 340L-02 **ISSUE F**



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	20.32	21.08	0.800	8.30	
В	15.75	16.26	0.620	0.640	
C	4.70	5.30	0.185	0.209	
D	1.00	1.40	0.040	0.055	
Е	1.90	2.60	0.075	0.102	
F	1.65	2.13	0.065	0.084	
G	5.45 BSC		0.215 BSC		
Н	1.50	2.49	0.059	0.098	
J	0.40	0.80	0.016	0.031	
K	19.81	20.83	0.780	0.820	
L	5.40	6.20	0.212	0.244	
N	4.32	5.49	0.170	0.216	
P		4.50		0.177	
Q	3.55	3.65	0.140	0.144	
J	6.15 BSC 0.242 BSC		BSC		
W	2.87	3.12	0.113	0.123	

STYLE 4: PIN 1. GATE

- 2. COLLECTOR 3. EMITTER
- 4. COLLECTOR

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